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Low Loss DuoPack : IGBT in TRENCHSTOP™ and Fieldstop technology with soft, fast recovery anti-parallel Emitter Controlled HE diode





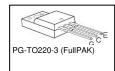




#### **Features**

- Very low V<sub>CE(sat)</sub> 1.5V (typ.)
- Maximum Junction Temperature 175°C
- Short circuit withstand time 5μs
- TRENCHSTOP™ and Fieldstop technology for 600V applications offers :
  - very tight parameter distribution
  - high ruggedness, temperature stable behavior
  - very high switching speed
- Low FMI
- Very soft, fast recovery anti-parallel Emitter Controlled HE diode
- Qualified according to JEDEC<sup>1</sup> for target applications
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models : <a href="http://www.infineon.com/igbt/">http://www.infineon.com/igbt/</a>





#### **Applications**

- Washing Machine
- Inverter and Variable Speed Drive

Туре	<b>V</b> <sub>CE</sub>	<b>I</b> c	V <sub>CE(sat), Tj=25°C</sub>	$T_{\rm j,max}$	Marking Code	Package
IKA06N60T	600V	6A	1.5V	175°C	K06T60	PG-TO220-3 (FullPAK)

#### **Maximum Ratings**

Parameter	Symbol	Value	Unit
Collector-emitter voltage, <i>T</i> <sub>j</sub> ≥ 25°C	V <sub>CE</sub>	600	V
DC collector current, limited by $T_{jmax}$			
$T_{\rm C} = 25^{\circ}{\rm C}$	I <sub>C</sub>	10	
$T_{\rm C}$ = 100°C		6.2	
Pulsed collector current, $t_p$ limited by $T_{jmax}$	I <sub>Cpuls</sub>	18	
Turn off safe operating area, $V_{CE} = 600V$ , $T_j = 175$ °C, $t_p = 1 \mu s$	-	18	A
Diode forward current, limited by $T_{jmax}$			
$T_{\rm C} = 25^{\circ}{\rm C}$	I <sub>F</sub>	10.2	
$T_{\rm C}$ = 100°C		6.5	
Diode pulsed current, $t_p$ limited by $T_{jmax}$	<i>I</i> <sub>Fpuls</sub>	18	
Gate-emitter voltage	$V_{GE}$	±20	V
Short circuit withstand time <sup>2)</sup>		E	_
$V_{\text{GE}}$ = 15V, $V_{\text{CC}} \le 400\text{V}$ , $T_{j} \le 150^{\circ}\text{C}$	tsc	5	μS
Power dissipation	P	28	w
$T_{\rm C} = 25^{\circ}{\rm C}$	$P_{tot}$	20	VV
Operating junction temperature	$T_{\rm j}$	-40+175	-°C
Storage temperature	$T_{stg}$	-55+150	
Isolation voltage	V <sub>isol</sub>	2500	V <sub>rms</sub>

1

<sup>&</sup>lt;sup>1</sup> J-STD-020 and JESD-022

<sup>&</sup>lt;sup>2)</sup> Allowed number of short circuits: <1000; time between short circuits: >1s.





#### **Thermal Resistance**

Parameter	Symbol	Conditions	Max. Value	Unit
Characteristic	<u> </u>			
IGBT thermal resistance,	R <sub>thJC</sub>		5.3	K/W
junction – case				
Diode thermal resistance,	$R_{thJCD}$		6.5	
junction – case				
Thermal resistance,	$R_{thJA}$		80	
junction – ambient				

### **Electrical Characteristic,** at $T_j = 25$ °C, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
Parameter	Symbol		min.	typ.	max.	Oilit
Static Characteristic						
Collector-emitter breakdown voltage	$V_{(BR)CES}$	$V_{\text{GE}}=0\text{V},$ $I_{\text{C}}=0.25\text{mA}$	600	-	-	V
Collector-emitter saturation voltage	$V_{\text{CE(sat)}}$	$V_{\rm GE} = 15  \rm V, \ I_{\rm C} = 6  \rm A$				
		<i>T</i> <sub>j</sub> =25°C	-	1.5	2.05	
		$T_j=175^{\circ}\text{C}$	-	1.8		
Diode forward voltage	$V_{F}$	$V_{GE}=0V$ , $I_{F}=6A$				
		$T_j=25^{\circ}\text{C}$	-	1.6	2.05	
		T <sub>j</sub> =175°C	-	1.6	-	
Gate-emitter threshold voltage	V <sub>GE(th)</sub>	$I_{\rm C} = 0.18  \rm m  A$	4.1	4.6	5.7	
		$V_{\text{CE}} = V_{\text{GE}}$				
Zero gate voltage collector current	ICES	$V_{CE} = 600  \text{V}, V_{GE} = 0  \text{V}$				μΑ
		$T_j=25^{\circ}\text{C}$	-	-	40	
		T <sub>j</sub> =175°C	-	-	700	
Gate-emitter leakage current	I <sub>GES</sub>	$V_{\text{CE}}=0\text{V}, V_{\text{GE}}=20\text{V}$	-	-	100	nA
Transconductance	$g_{fs}$	$V_{\rm CE} = 20  \rm V, \ I_{\rm C} = 6  \rm A$	-	3.6	-	S
Integrated gate resistor	R <sub>Gint</sub>			none		Ω

### **Dynamic Characteristic**

Input capacitance	Ciss	V <sub>CE</sub> =25V,	-	368	-	pF
Output capacitance	Coss	$V_{GE}=0V$ ,	-	28	-	
Reverse transfer capacitance	$C_{rss}$	f=1MHz	-	11	-	
Gate charge	Q <sub>Gate</sub>	$V_{\rm CC} = 480  \text{V}, I_{\rm C} = 6  \text{A}$	-	42	-	nC
		V <sub>GE</sub> =15V				
Internal emitter inductance	LE		-	7	-	nΗ
measured 5mm (0.197 in.) from case						
Short circuit collector current <sup>1)</sup>	$I_{C(SC)}$	$V_{\text{GE}} = 15 \text{V}, t_{\text{SC}} \le 5 \mu \text{s}$ $V_{\text{CC}} = 400 \text{V},$ $T_{\text{j}} = 25 ^{\circ} \text{C}$	-	55	-	A

<sup>&</sup>lt;sup>1)</sup> Allowed number of short circuits: <1000; time between short circuits: >1s.





### Switching Characteristic, Inductive Load, at $T_j$ =25 °C

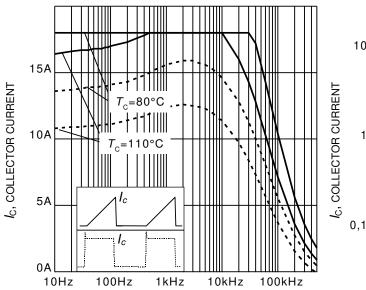
Davamatav	Cumbal	Conditions		11		
Parameter	Symbol		min.	Тур.	max.	Unit
IGBT Characteristic	•					
Turn-on delay time	$t_{d(on)}$	$T_j=25^{\circ}\text{C}$	-	9.4	-	ns
Rise time	t <sub>r</sub>	$V_{\text{CC}} = 400 \text{ V}, I_{\text{C}} = 6 \text{ A},$ $V_{\text{GE}} = 0/15 \text{ V}, r_{\text{G}} = 23 \Omega,$	-	5.6	-	
Turn-off delay time	$t_{d(off)}$	$L_{\sigma}=60\text{nH}, C_{\sigma}=40\text{pF}$	-	130	-	
Fall time	t <sub>f</sub>	]	-	58	-	
Turn-on energy	Eon	$L_{\sigma}$ , $C_{\sigma}$ from Fig. E Energy losses include	-	0.09	-	mJ
Turn-off energy	E <sub>off</sub>	"tail" and diode reverse	-	0.11	-	
Total switching energy	Ets	recovery.	-	0.2	-	
Anti-Parallel Diode Characteristic						
Diode reverse recovery time	$t_{rr}$	T <sub>j</sub> =25°C,	-	123	-	ns
Diode reverse recovery charge	$Q_{rr}$	$V_{R}$ =400V, $I_{F}$ =6A,	-	190	-	nC
Diode peak reverse recovery current	I <sub>rrm</sub>	$di_{\rm F}/dt$ =550A/ $\mu$ s	-	5.3	-	Α
Diode peak rate of fall of reverse recovery current during $t_{\rm b}$	di <sub>rr</sub> /dt		-	450	-	A/μs

### Switching Characteristic, Inductive Load, at $T_j$ =175 °C

Devenueter	Symbol	Conditions	Value			I I mid
Parameter			min.	typ.	max.	Unit
IGBT Characteristic						
Turn-on delay time	$t_{d(on)}$	$T_{\rm j}=175^{\circ}{\rm C}$	-	8.8	-	ns
Rise time	$t_{r}$	$V_{\text{CC}} = 400 \text{ V}, I_{\text{C}} = 6 \text{ A},$ $V_{\text{GE}} = 0/15 \text{ V}, r_{\text{G}} = 23 \Omega,$	-	8.2	-	
Turn-off delay time	$t_{d(off)}$	$L_{\sigma}$ =60nH, $C_{\sigma}$ =40pF	-	165	-	
Fall time	t <sub>f</sub>	], , , , ,	-	84	-	
Turn-on energy	Eon	$L_{\sigma}$ , $C_{\sigma}$ from Fig. E Energy losses include	-	0.14	-	mJ
Turn-off energy	E <sub>off</sub>	"tail" and diode reverse	-	0.18	-	
Total switching energy	Ets	recovery.	-	0.335	-	
Anti-Parallel Diode Characteristic						
Diode reverse recovery time	$t_{rr}$	<i>T</i> <sub>j</sub> =175°C	-	180	-	ns
Diode reverse recovery charge	$Q_{rr}$	$V_{R}$ =400V, $I_{F}$ =6A,	-	500	-	nC
Diode peak reverse recovery current	$I_{\rm rrm}$	$di_{\rm F}/dt$ =550A/ $\mu$ s	-	7.6	-	Α
Diode peak rate of fall of reverse recovery current during $t_{\rm b}$	di <sub>rr</sub> /dt		-	285	-	A/μs







10A

10A

10A

10A

10μs

10μs

10μs

50μs

10μs

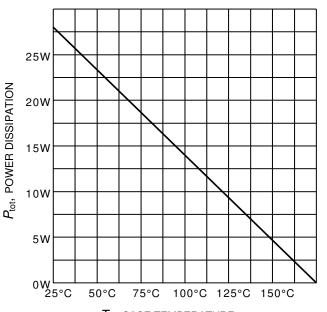
f, SWITCHING FREQUENCY

Figure 1. Collector current as a function of switching frequency  $(T_i \le 175^{\circ}\text{C}, D = 0.5, V_{\text{CE}} = 400\text{V},$ 

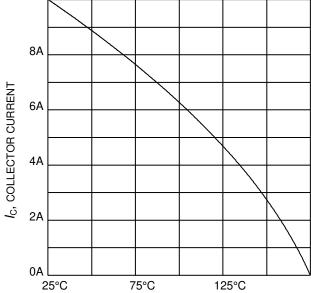
 $V_{\rm GE} = 0/15 \text{V}, r_{\rm G} = 23 \Omega$ 

 $V_{\rm CE}$ , COLLECTOR-EMITTER VOLTAGE

Figure 2. Safe operating area  $(D = 0, T_C = 25^{\circ}C, T_i \le 175^{\circ}C; V_{GE} = 0/15V)$ 







 $T_{\rm C}$ , CASE TEMPERATURE Figure 4. Collector current as a function of case temperature  $(V_{\rm GE} \geq 15 {\rm V}, \ T_{\rm i} \leq 175 {\rm ^{\circ}C})$ 





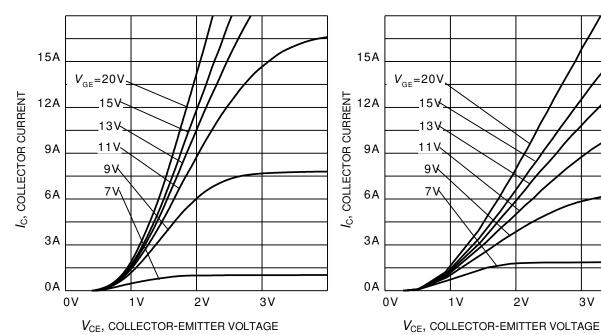


Figure 5. Typical output characteristic  $(T_i = 25^{\circ}C)$ 

Figure 6. Typical output characteristic  $(T_i = 175^{\circ}C)$ 

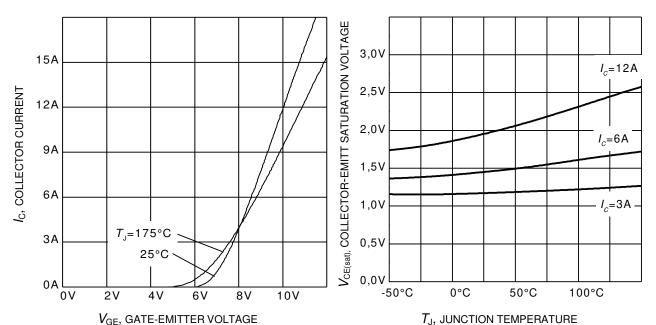


Figure 7. Typical transfer characteristic  $(V_{CE}=20V)$ 

Figure 8. Typical collector-emitter saturation voltage as a function of junction temperature  $(V_{GE} = 15V)$ 





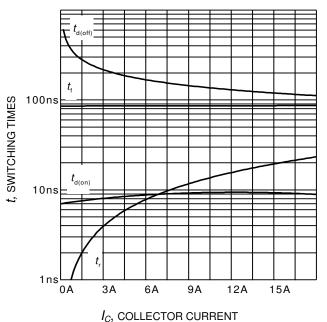


Figure 9. Typical switching times as a function of collector current (inductive load,  $T_J$ =175°C,  $V_{CE}$  = 400V,  $V_{GE}$  = 0/15V,  $r_G$  = 23 $\Omega$ , Dynamic test circuit in Figure E)

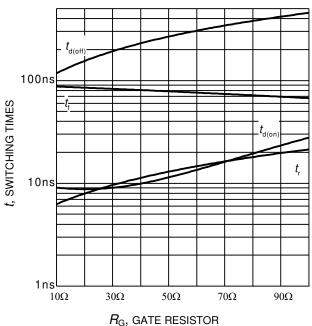


Figure 10. Typical switching times as a function of gate resistor (inductive load,  $T_J$ =175°C,  $V_{CE}$  = 400V,  $V_{GE}$  = 0/15V,  $I_C$  = 6A, Dynamic test circuit in Figure E)

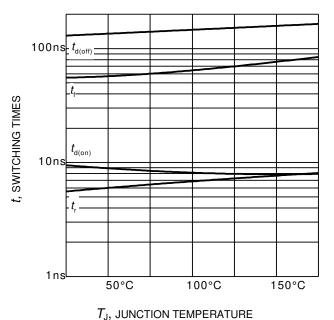


Figure 11. Typical switching times as a function of junction temperature (inductive load,  $V_{\text{CE}} = 400\text{V}$ ,  $V_{\text{GE}} = 0/15\text{V}$ ,  $I_{\text{C}} = 6\text{A}$ ,  $I_{\text{C}} = 23\Omega$ , Dynamic test circuit in Figure E)

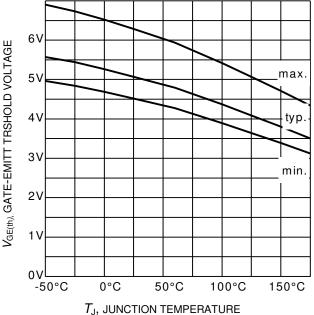
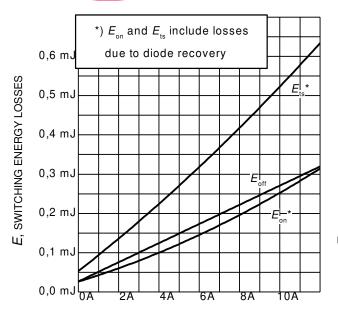


Figure 12. Gate-emitter threshold voltage as a function of junction temperature ( $I_C = 0.18\text{mA}$ )

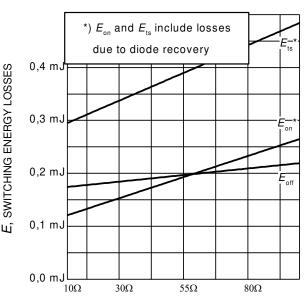






 $I_C$ , COLLECTOR CURRENT

Figure 13. Typical switching energy losses as a function of collector current (inductive load,  $T_{J}$ =175°C,  $V_{CE}$ =400V,  $V_{GE}$ =0/15V,  $r_{G}$ =23 $\Omega$ , Dynamic test circuit in Figure E)



 $R_{\rm G}$ , GATE RESISTOR

Figure 14. Typical switching energy losses as a function of gate resistor (inductive load,  $T_J$ =175°C,  $V_{CE}$  = 400V,  $V_{GE}$  = 0/15V,  $I_C$  = 6A, Dynamic test circuit in Figure E)

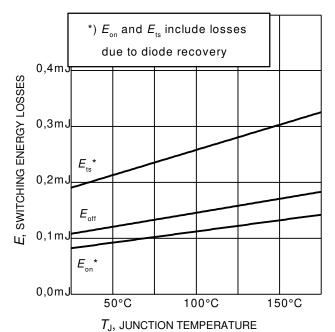
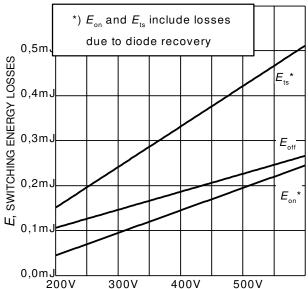


Figure 15. Typical switching energy losses as a function of junction temperature

(inductive load,  $V_{\rm CE}$ =400V,  $V_{\rm GE}$  = 0/15V,  $I_{\rm C}$  = 6A,  $r_{\rm G}$  = 23 $\Omega$ , Dynamic test circuit in Figure E)



 $V_{\it CE}$ , COLLECTOR-EMITTER VOLTAGE

Figure 16. Typical switching energy losses as a function of collector emitter voltage

(inductive load,  $T_J$  = 175°C,  $V_{GE}$  = 0/15V,  $I_C$  = 6A,  $r_G$  = 23 $\Omega$ , Dynamic test circuit in Figure E)





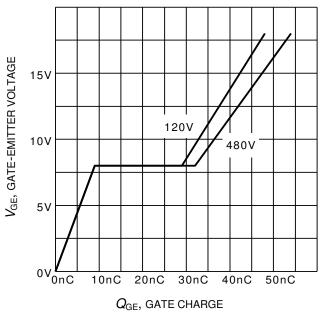
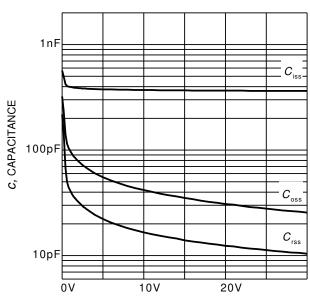


Figure 17. Typical gate charge  $(I_{\rm C}=6~{\rm A})$ 



 $V_{\rm CE}$ , COLLECTOR-EMITTER VOLTAGE

Figure 18. Typical capacitance as a function of collector-emitter voltage  $(V_{GE}=0V, f=1 \text{ MHz})$ 

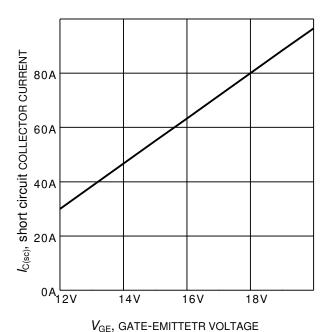
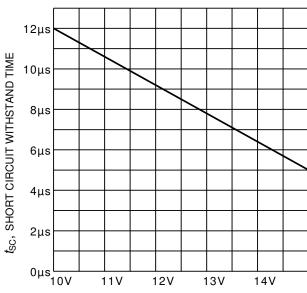


Figure 19. Typical short circuit collector current as a function of gate-emitter voltage  $(V_{CE} \le 400 \text{V}, T_i \le 150 ^{\circ}\text{C})$ 



 $V_{\mathrm{GE}}$ , gate-emitetr voltage

Figure 20. Short circuit withstand time as a function of gate-emitter voltage ( $V_{\text{CE}}$ =400V, start at  $T_{\text{J}}$ =25°C,  $T_{\text{Jmax}}$ <150°C)





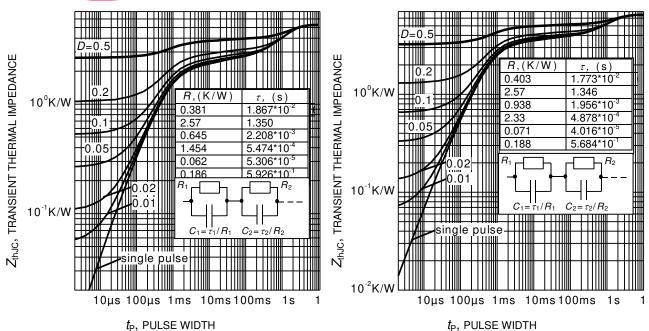


Figure 21. IGBT transient thermal impedance  $(D = t_0 / T)$ 

Figure 22. Diode transient thermal impedance as a function of pulse width  $(D=t_P/T)$ 

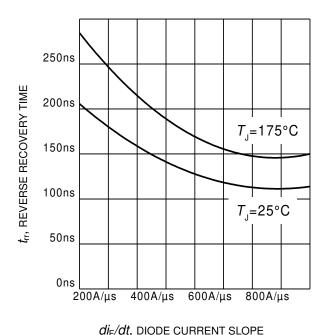
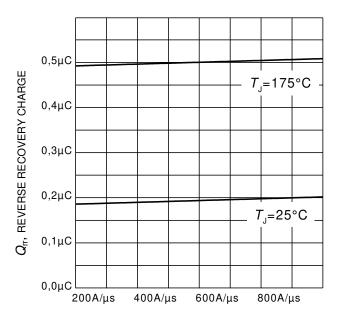


Figure 23. Typical reverse recovery time as a function of diode current slope ( $V_R = 400 \text{V}$ ,  $I_F = 6 \text{A}$ ,

Dynamic test circuit in Figure E)

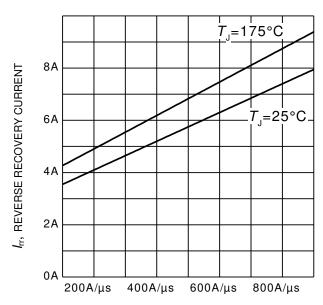


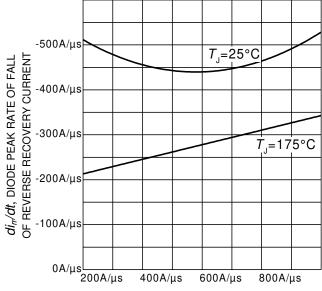
di<sub>F</sub>/dt, DIODE CURRENT SLOPE

Figure 24. Typical reverse recovery charge as a function of diode current slope

 $(V_R = 400V, I_F = 6A,$ Dynamic test circuit in Figure E)







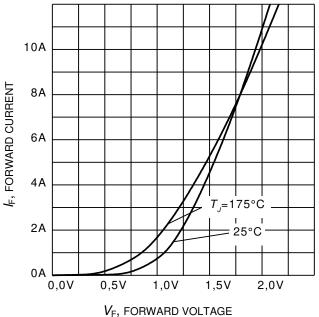
di<sub>F</sub>/dt, DIODE CURRENT SLOPE

Figure 25. Typical reverse recovery current as a function of diode current slope

( $V_R = 400V$ ,  $I_F = 6A$ , Dynamic test circuit in Figure E)

di<sub>F</sub>/dt, DIODE CURRENT SLOPE

Figure 26. Typical diode peak rate of fall of reverse recovery current as a function of diode current slope ( $V_R = 400V$ ,  $I_F = 6A$ , Dynamic test circuit in Figure E)



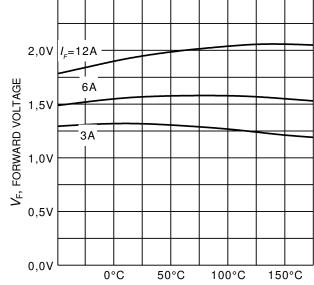


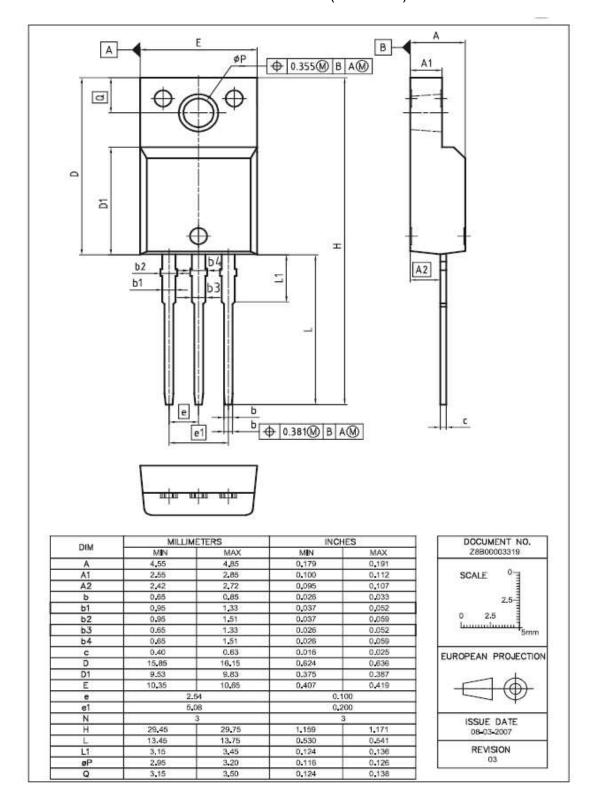
Figure 27. Typical diode forward current as a function of forward voltage

Figure 28. Typical diode forward voltage as a function of junction temperature

 $T_{\rm J}$ , JUNCTION TEMPERATURE

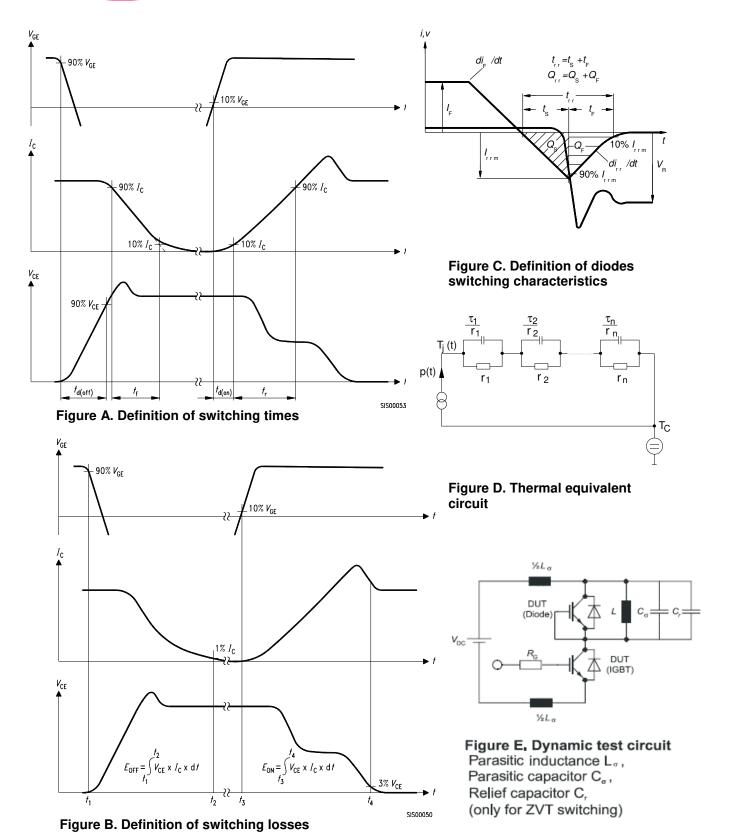


## PG-TO220-3 (FullPAK)



#### Please refer to mounting instructions









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